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4. Application number(s) or patent number(s):   This document is being filed together with a new application			
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**PATENT** 

## ROTHWELL, FIGG, ERNST & MANBECK

Docket No: 3209-111

## U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by:

Mitsui Mining & Smelting Co., Ltd. 11-1, Osaki 1-chome, Shinagawa-ku, Tokyo 141-8584, Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE all of his right, title and interest to the invention entitled:

COPPER FOIL WITH ULTRA THIN ADHESIVE LAYER, AND A METHOD FOR MANUFACTURING THE COPPER FOIL WITH ULTRA THIN ADHESIVE LAYER

for which application for Letters Patent of the United States ASSIGNOR was one of the listed inventors, which application was executed on even date herewith unless otherwise indicated below:

filed on July 15, 2004; Serial No. PCT/JP2004/010101

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as ASSIGNEE may deem necessary or expedient.

ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventors have affixed their signatures.

Tetsuro SATO	7. Satch	02/08/2006
Toshifumi MATSUSHIMA	(SIGNATURE) Tochilumi Mateuchima	(DATE)
_	(SIGNATURE)	(DATE)